

FIIF

Sami Lehtonen
Market product manager
Vision, Measuring, Ranging, Ident

SICK
Sensor Intelligence.



- Erwin Sick perusti yrityksen **1946** saatuaan luvan USA:n hallitukselta harjoittaa insinöörin ammattia Saksassa
- Ensimmäinen **valoverho** 1950 Munchenissä.
- Vuonna 1956 ensimmäinen **merkittävä patentti valokennoille**. Tästä rakentui SICKin kivijalka pitkäksi ajaksi.
- Ensimmäinen **laserskanneri** näki päivänvalon vuonna 1969.
- SICK oli ensimmäinen yritys maailmassa, joka teki es **SICK** – maailman johtava anturien ja erilaisten anturisovellusten kehittäjä sekä valmistaja



→ *SICK - maailman
johtava anturien ja
erilaisten
anturisovellusten
kehittäjä ja valmistaja*

72

vuoden kokemus
anturiteknologiasta

9,800

työntekijää ympäri maailman

88

maata, jossa SICK edustettuna.
Yli 50 omaa tytäryhtiötä.

1,500

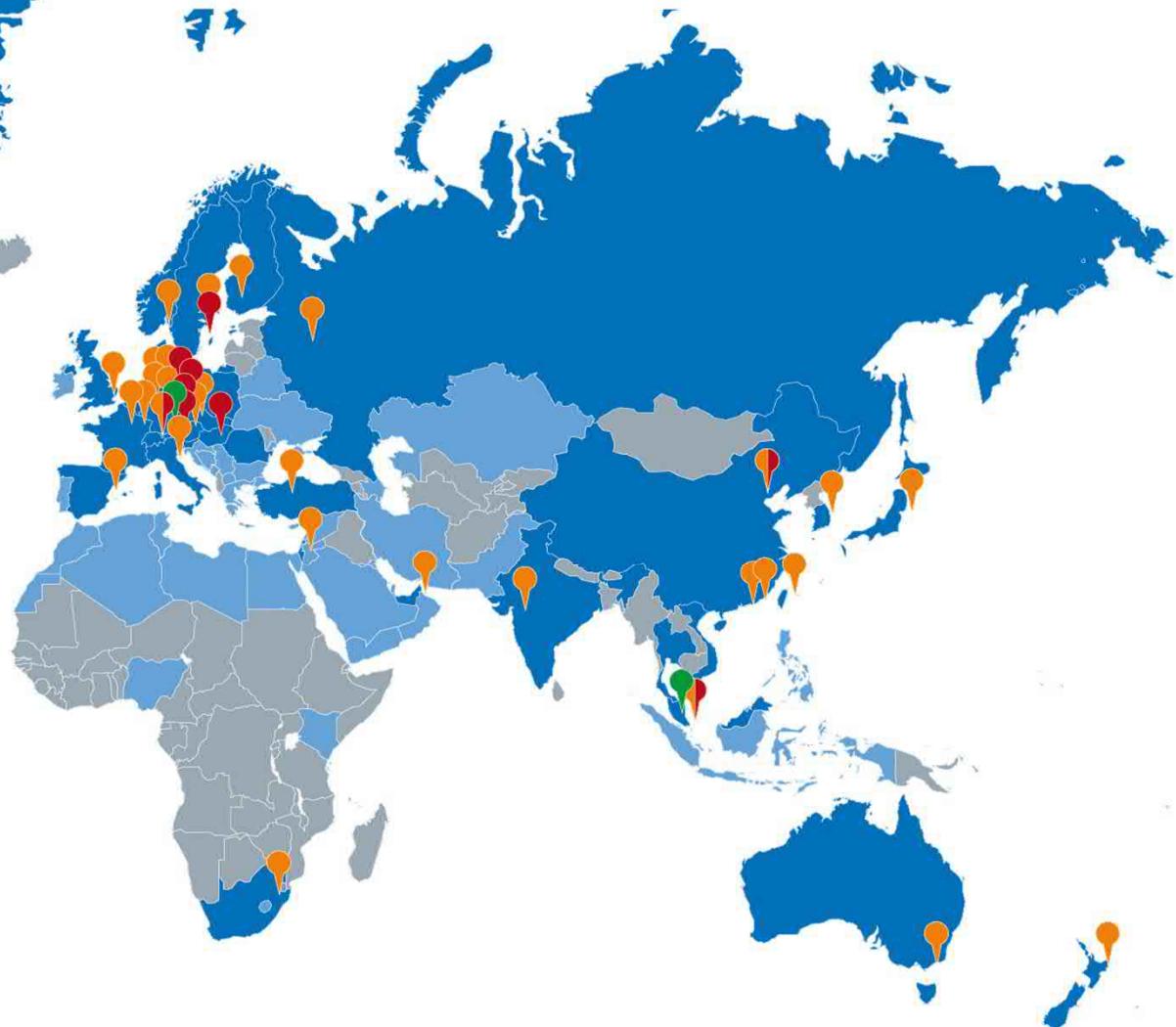
Konsernin myynti vuonna 2017

40,000

tuotetta. Laajin tuote- ja
teknologiatarjonta
anturisovelluksiin.

3,000

patenttia ja johtava teknologian
kehittäjä. Sensor Intelligence.



- **27 vuotta** anturien ja anturisovellusten myyntiä Suomessa. Läsnäolo ja apu turvattua myös tulevaisuudessa.
- **43 työntekijää**, kaikki palvelemassa ja auttamassa asiakkaitamme.
- **Liikevaihto 21 M€** vuonna 2018, kiitos asiakkaillemme.
- Tuotteiden lisäksi ammattitaitoista **sovellusosaamista** ja halua aitooon yhteistyöhön asiakkaiden ja kumppanien kanssa.
- **Aidosti ihmisiä arvostava yritys**
- Yksi Suomen parhaista työpaikoista.



SICK – markkinajohtaja myös Suomessa



SICK ANTURISOVELLUKSIA ERI ALOILLA JA ARJESSA

SICK
Sensor Intelligence.



SICK ANTURISOVELLUKSIA ERI ALOILLA JA ARJESSA

SICK
Sensor Intelligence.



- Long experience (>25y) and from wide range of applications and industries with well proven technology
- Collaborative mindset, making our customers successful and focus on their core values
- Superior 3D technology platform (m30 benefits, values)
- Intimate customer SW-support (Special calibration, FOV extension by alignment, EzR SDK etc)
- Customized HWsolutions (Ruler-X3)

- Things to include
 - ▶ M30 description
 - ▶ Ranger3 description
 - ▶ AppSpace?
 - ▶ Ranger-X3 overview

SICK - YOUR MACHINE VISION PARTNER

YOUR INDUSTRY - OUR FOCUS

SICK
Sensor Intelligence.

Wide range of 2D and 3D Vision products for each task



25 years of experience in 3D Vision applications from various industries world wide by proven technology



Proprietary 3D CMOS sensor technology for superior performance, 3D data quality and unmatched abilities



Collaborative mindset to make our clients successful

- Devoted key customer support
- Customized software tools
- Customized hardware solutions



EzR

EzR
CAL

SICK'S VISION PORTFOLIO

OVERVIEW

SICK
Sensor Intelligence.

	2D vision			3D vision
Configurable 	Inspector 	Lector62x 	Lector63x 	TriSpector1000 
Programmable 	InspectorP6xx 			IVC-3D / Trispector P 
Streaming 	picoCam 	midiCam 	Ranger 	Ruler  ScanningRuler 

SICK AppSpace



Sensor Integration Machine - SIM4000



SICK 3D VISION

INDUSTRIES AND APPLICATIONS



- **SICK 3D products** are key components in inspection machines and applications in a wide range of industries world wide

- **They are used by**
 - ▶ OEM to build advanced inspection systems
 - ▶ SI and EU to solve wide range of inspection tasks

- **Industries and application examples**

- ▶ Tire and rubber quality control
- ▶ Board grading and Log measurement (Wood)
- ▶ Components and PCB inspection
- ▶ Robot Belt/Bin picking and Palletizing
- ▶ Railway and Road inspection
- ▶ Box content/ quality control in Consumer goods
- ▶ Quality grading and Portioning of food



BENEFITS FOR YOUR APPLICATION



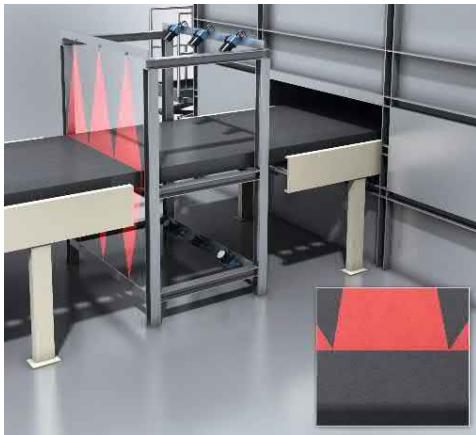
Electronic component and PCB inspection



Tire quality control



High speed railway and road surface inspection



Metal and steel inspection



Packaging and food quality control



Quality inspection of wood and board



- **What it is:**

- ▶ SICK Programmable devices
- ▶ SICK AppStudio: Development platform **by developers for developers**
- ▶ SICK AppSpace Developer's Club: Community for developers



- **What it enables:**

- ▶ With SICK AppSpace a sensor can get 100 % tailored to the customer needs
 - Customers IP or specific application solution in SICK's hardware
- ▶ SICK AppSpace eco-system to open paths to new possibilities for application solutions
- ▶ New business models and opportunities with integration partners and OEMS

- **More than a Machine Vision story**

- ▶ SICK AppSpace evolves to the entire SICK portfolio
- ▶ Part of the big picture of Cloud, Smart Services and Industry 4.0
- ▶ SICK AppSpace continuously improves and evolves

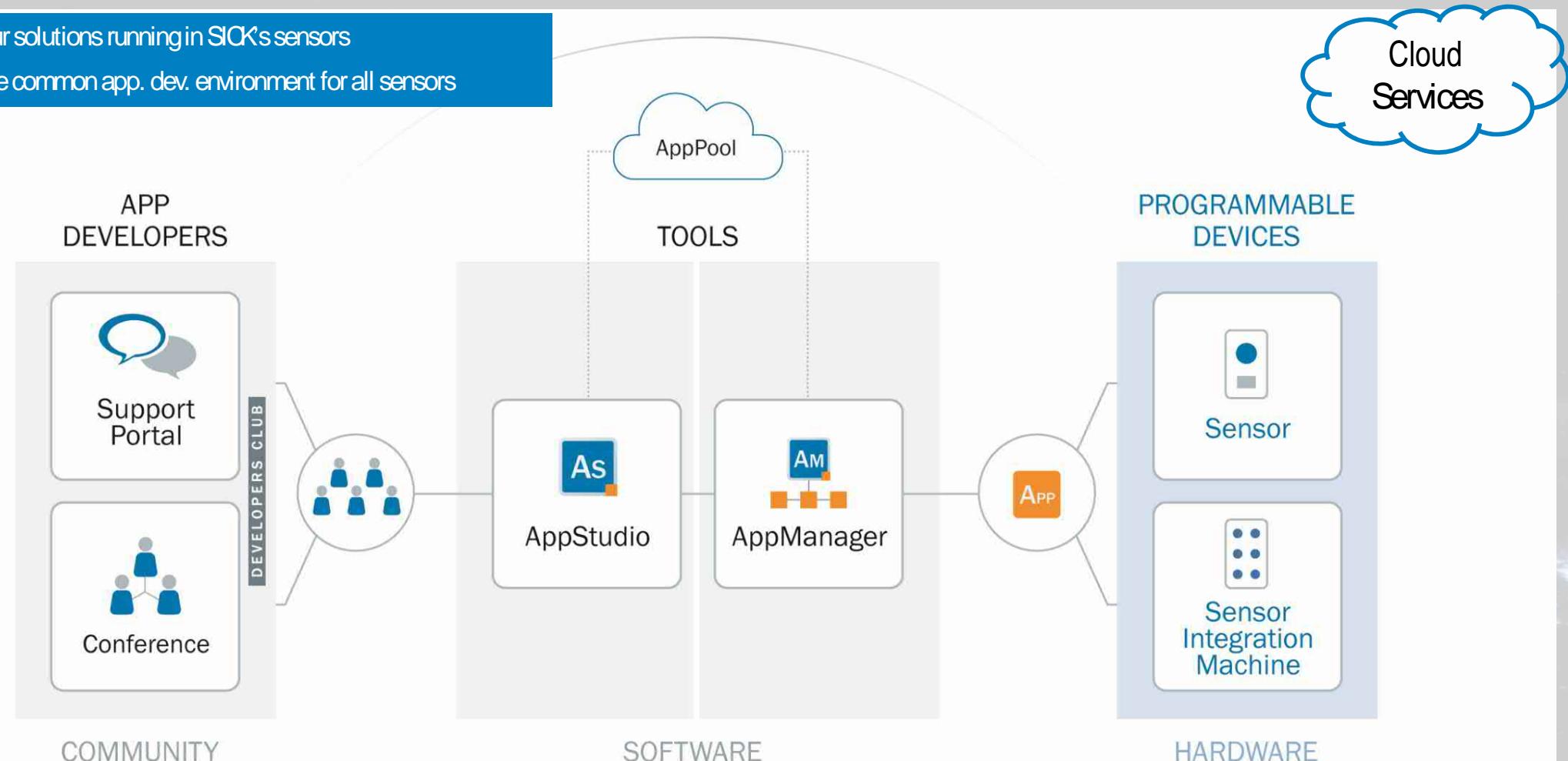


SICK AppSpace

RECENT DEVELOPMENTS AND PLANS

SICK
Sensor Intelligence.

- + Your solutions running in SICK's sensors
- + One common app. dev. environment for all sensors

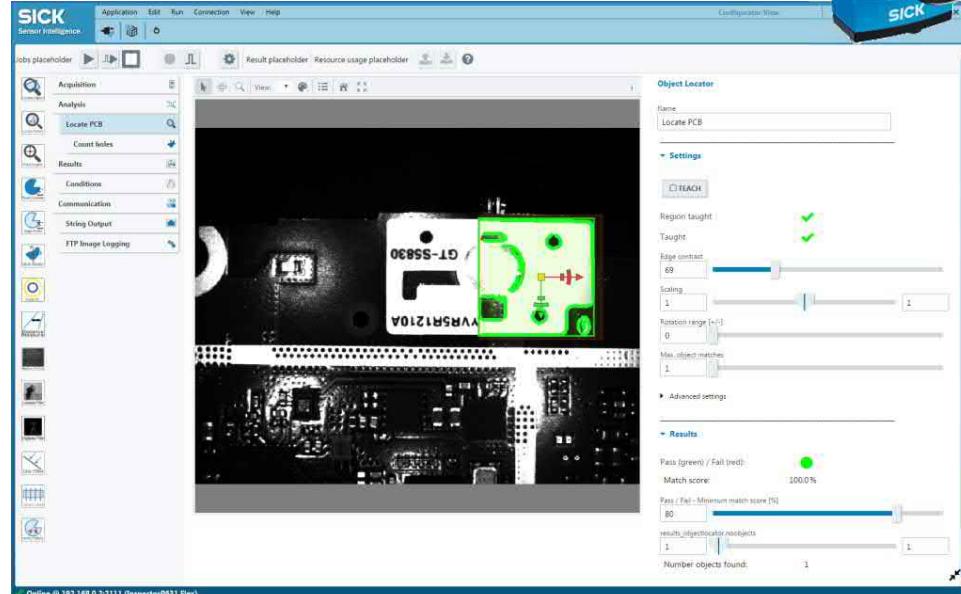


VISION APPTEMPLATES

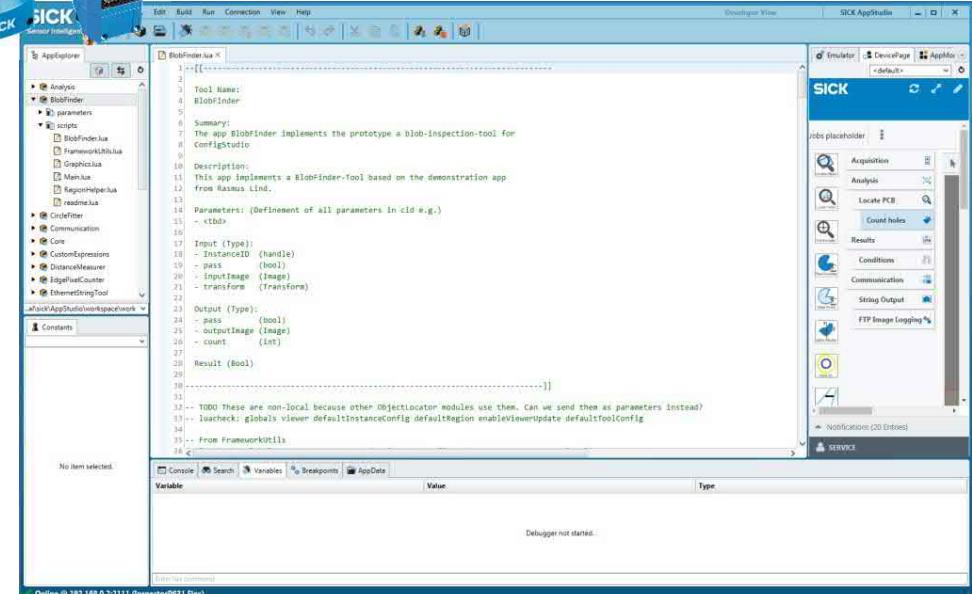
SEAMLESS FROM FEASIBILITY STUDY TO SPECIFIC SOLUTION



QUICKLY SOLVE 90% AND...



...PROGRAM THE LAST 10% DETAILS

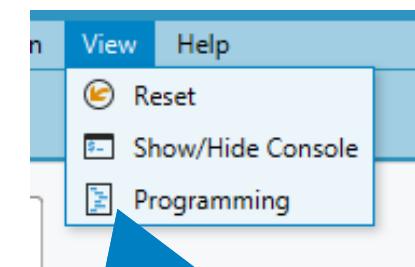
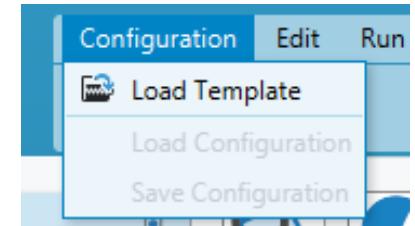
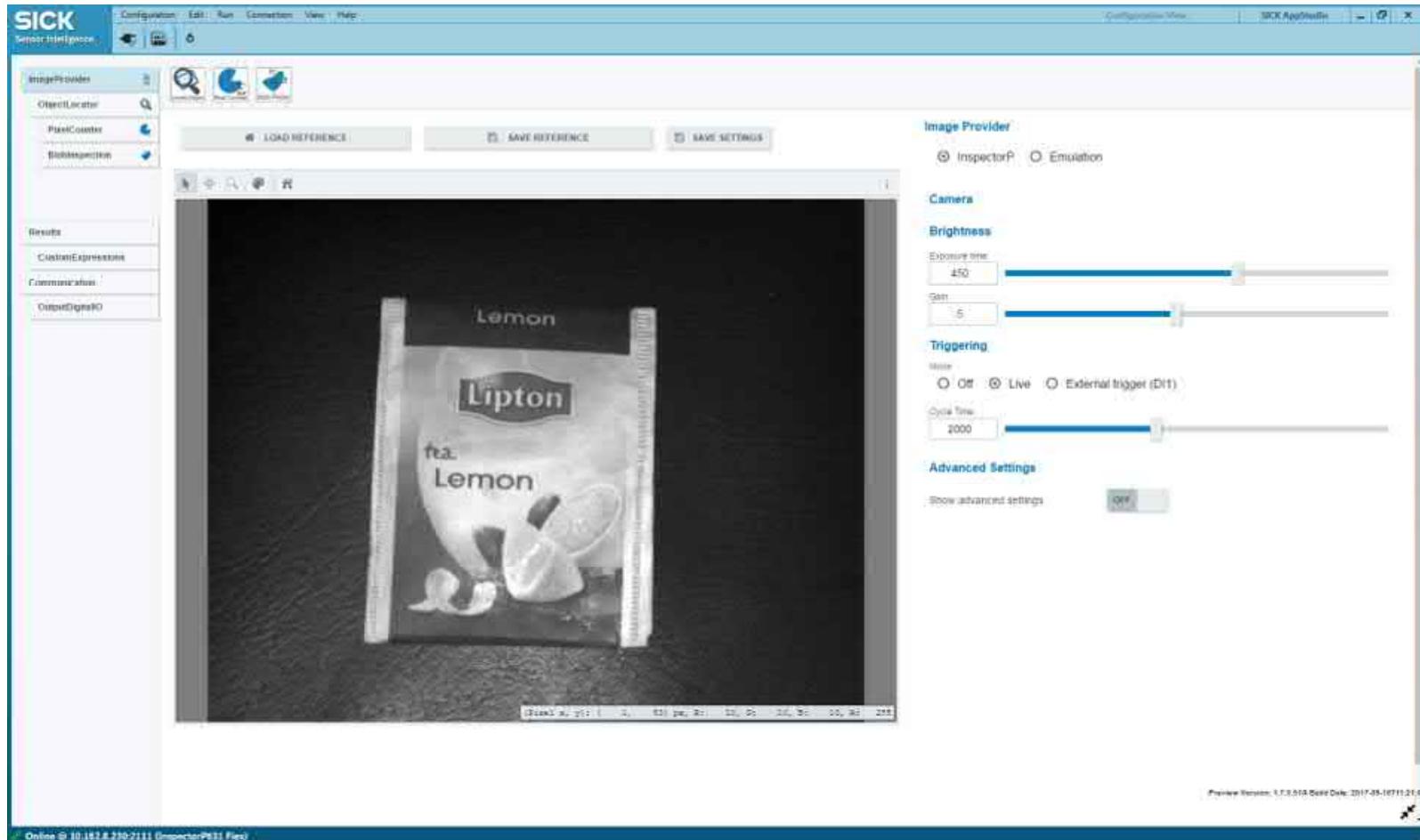


FEATURES

- 2D Vision AppTemplate (VAT2D) pre-installed on all InspectorP6xx variants
- Tools to solve general applications
- Easy to use configurable user interface
- Full programmability with open source code
- Open source code for customization and add-on

CUSTOMER BENEFITS

- Quickly solve and improve general vision applications
- Quick configurable feasibility study
- Specific needs quickly solved with AppStudio programming
- Jump-start development
- Framework for continuous tool and feature expansion
- Open for company specific look and feel



- + Build own tool set for re-use => Customer's own platform of modules for rapid development
- + Eg Communication tool to PLC/ Robot, I/O module, Image processing tools, etc etc.

Purchased license of AppStudio required for access and possibility to develop, edit and add tools and templates





Inspector P63x

- 1.3 and 1.9 MP monochrome
- Flexible optics and lighting
- S- and C-mount



Inspector P64x

- 1.7 MP monochrome
- Flexible optics and lighting
- C-mount



Inspector P65x

- 2.1 and 4.2 MP monochrome
- Flexible optics and lighting, or Dynamic Focus
- C-mount



SETTING A NEW STANDARD FOR HIGH SPEED 3D

RANGER3
BIG 3D PERFORMANCE IN A SMALL PACKAGE



Fast, Compact and Versatile

Superior 3D performance and image quality in compact housing

- ▶ Unique performance and quality by SICK designed CMOS 3D sensor chip
- ▶ Powerful. Reliable.
 - World class speed with 7kHz full sensor and up to 46kHz (1600x128px region)
 - 2560 x 832 pixels (6µm) sensor for 3D using 1" C-optics
 - Reliable and accurate 3D algorithm (1/ 16th sub-pixling) at full speed
 - High light sensitivity and High Dynamic Range mode
- ▶ Compact. Industrial.
 - Compact metal house, IP65/ 67 protection by accessory
 - Filter and Scheimpflug concepts for improved 3D data quality
 - Operating temperature 0-50° C (by appropriate mounting)
 - Gigabit Ethernet and Power I/O using M12 connectors for reliable connection
 - Compliant to the GgEVision/ GenICam standards for easy integration



KEY MESSAGES

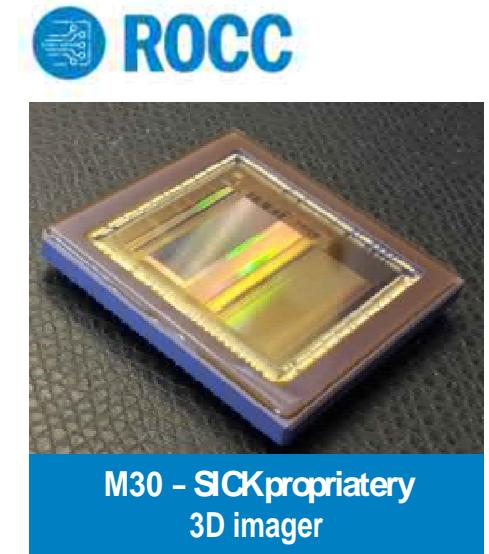
SETTING NEW STANDARDS TO 3D VISION



SICK
Sensor Intelligence.

▪ SICK has developed a unique high-speed 3D CMOS sensor

- ▶ Rapid On-Chip Calculations (ROCC) for outstanding 3D speed and quality with high accuracy
- ▶ Superior 3D Speed, always high 3D accuracy:
7kHz full sensor, up to 75kHz at full X-resolution (2560px) possible
- ▶ Reliable and accurate 3D using novel algorithms



▪ SICK is offering a new generation Ranger for superior performance

- ▶ Superior 3D performance and image quality in compact housing
- ▶ Great 3D Speed at high accuracy, even for large height ranges:
 - 7kHz full sensor and up to 30kHz in full X-res (bandwidth limited, 1xGigE)
 - Up to 46kHz by reducing X-resolution (1600px)
- ▶ Start of new Ranger portfolio, variants to follow



Ranger3 - SICK's new generation of 3D Cameras

NEW GENERATION 3D PRODUCTS

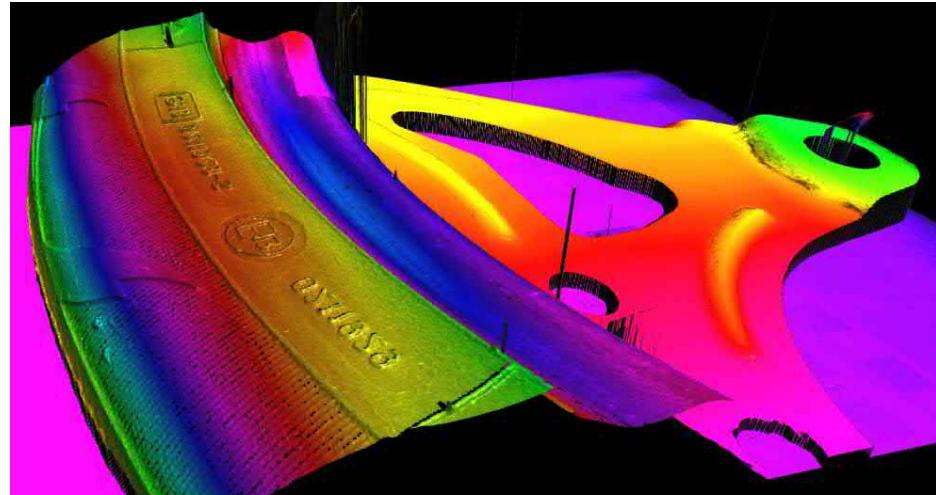
CUSTOMER VALUES



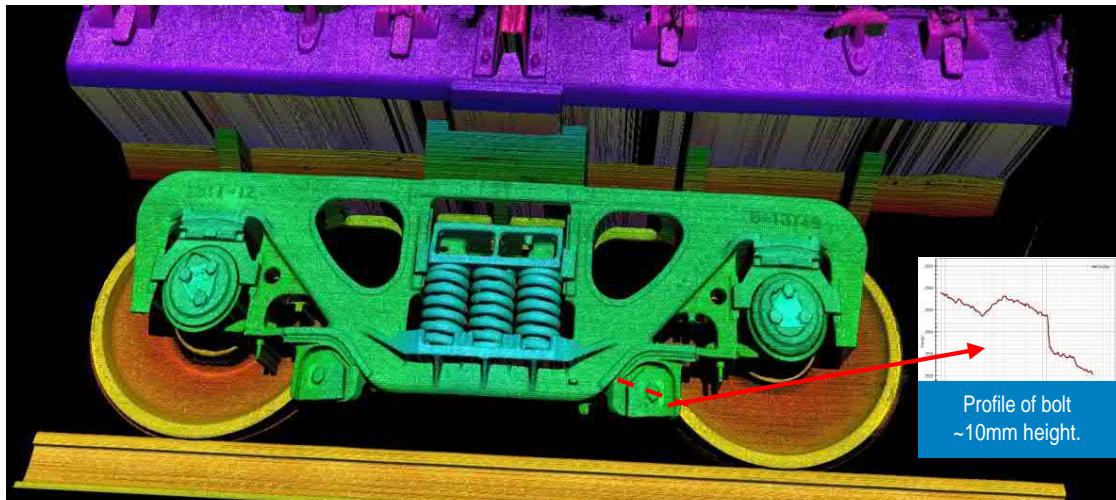
SICK
Sensor Intelligence.

The new SICK 3D CMOS sensor enables

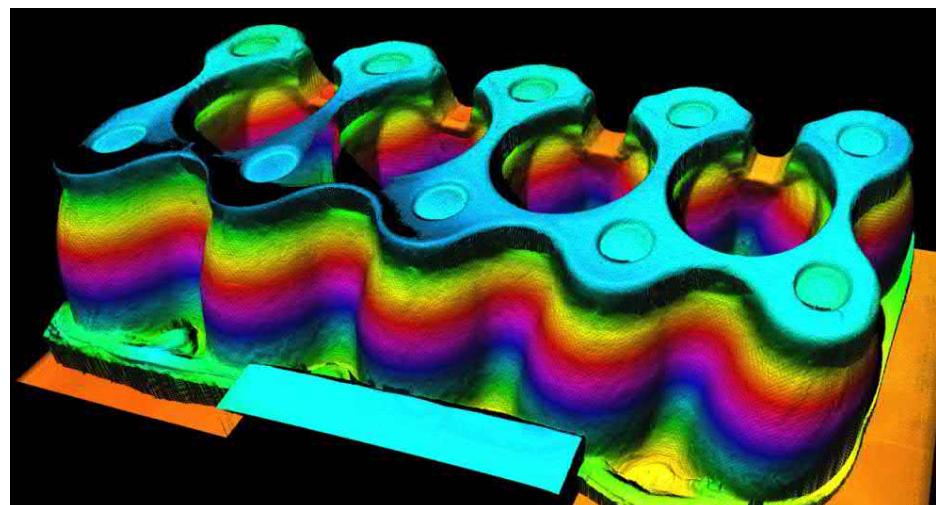
- More reliable measurements**
 - Both on dark and bright parts
- Reduced integration and maintenance effort**
 - Easy to get good data on wide range of materials
- Improved quality by more accurate measurements**
 - High sensor resolution and high precision 3D algorithm
 - Very high 3D speed
 - Large depth of field without speed reduction



Reliable 3D with high dynamic range (20kHz):
Dark rubber and shiny metal



High speed 3D at large FOV (30kHz, >1,5m DOF):
Train scanning at 120km/h (equiv.) with sub-millimeter resolution



Short setup time:
Same settings for e.g. Packaging material

M30 - HIGH PERFORMANCE 3D SENSOR CHIP

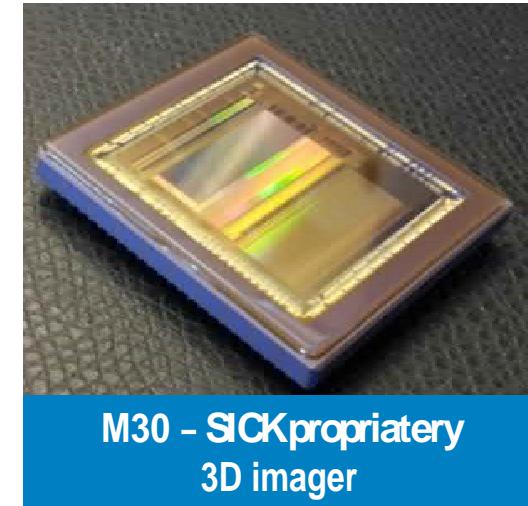
SICK ENGINEERED CMOS SENSOR TECHNOLOGY



SICK
Sensor Intelligence.

■ Features and performance

- ▶ CMOS sensor, Rapid-On-Chip-Calculations for superior 3D performance
- ▶ Market leading 3D performance and image quality
- ▶ Resolution: **2560 x 832 pixels (6µm)**
- ▶ Speed: **75kHz** at 80 rows, **30kHz** at 200 rows, **7kHz** full sensor
 - at highest precision 3D (16bit) and full X-resolution
- ▶ High resolution grayscale or/ and **RGB-color** in parallel at **5120px** resolution
- ▶ MultiScan for complete inspections (e.g. 3D+Color+Laser Scatter) by one camera

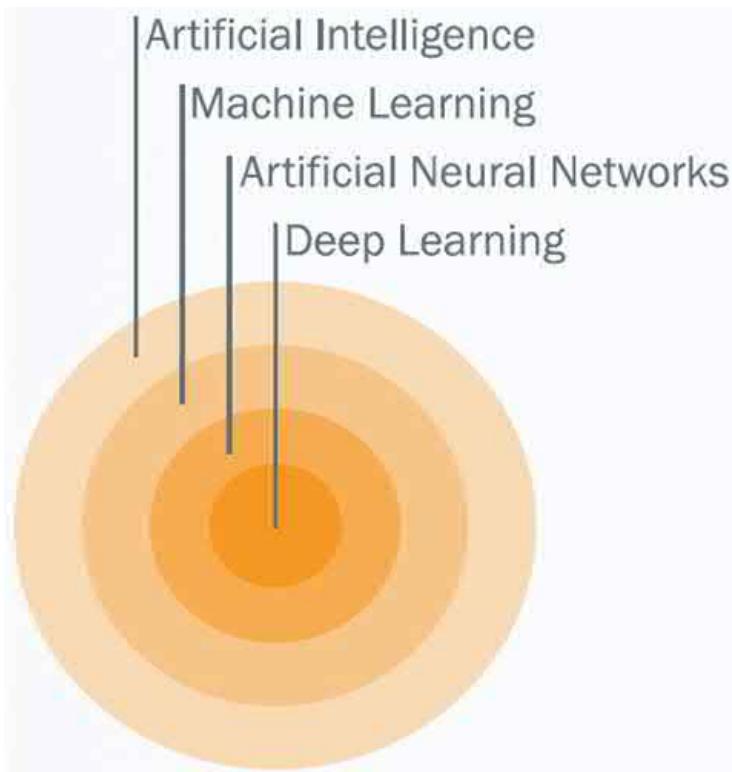


M30 - SICKproprietary
3D imager



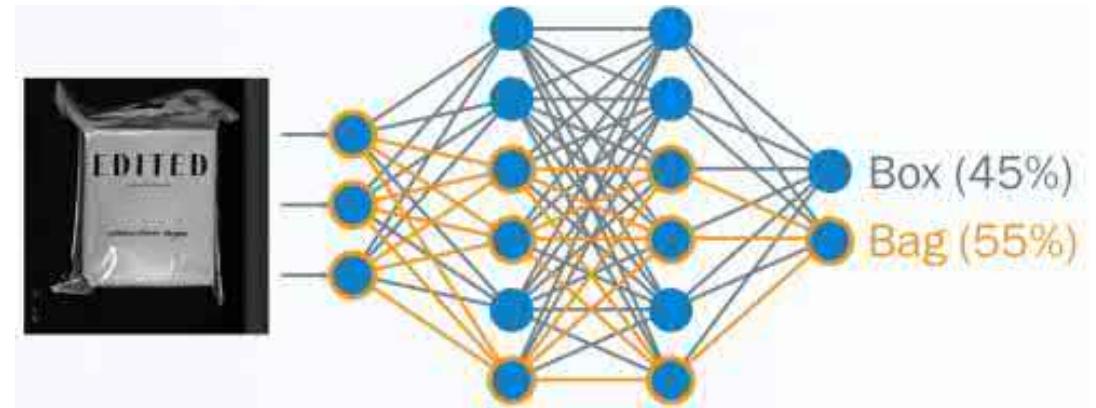
■ High data quality

- ▶ High light sensitivity allows for higher speeds w/o need for higher laser power
- ▶ Dynamic and accurate 3D detection algorithm on chip (1/16th sub-pixel)
- ▶ High Dynamic Range mode to further extend ability to measure on mix of very dark and bright objects
- ▶ Global shutter pixels (PPD) for improved usability and 3D data quality
- ▶ “Local-global-shutter” with individual ROI exposure time for optimal image quality in MultiScan
- ▶ Multiple peak extraction for reflection handling



<https://leonardoaraujosantos.gitbooks.io/artificial-intelligence/content/> :

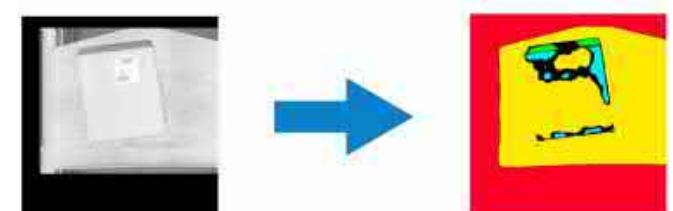
“Deep Learning is a machine learning technique that can learn useful representations or features directly from images, text and sound”



- Visual and plain result

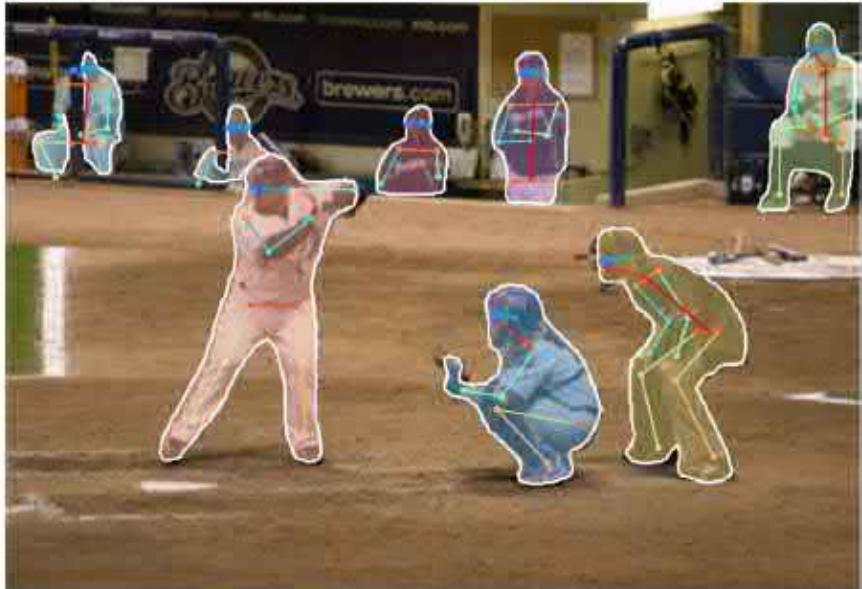


- Errors interpretable



QUANTUM LEAP IN COMPUTER VISION TASKS AND IN SPEECH RECOGNITION

SICK
Sensor Intelligence.

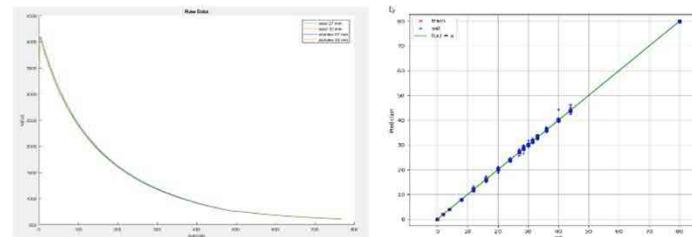


DEEP LEARNING INDUSTRIAL DATA?

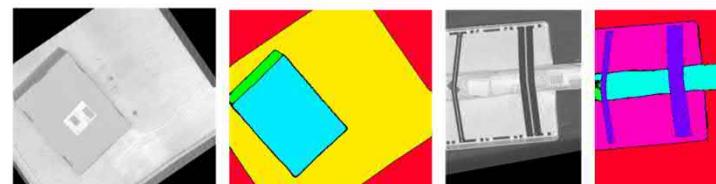


SICK
Sensor Intelligence.

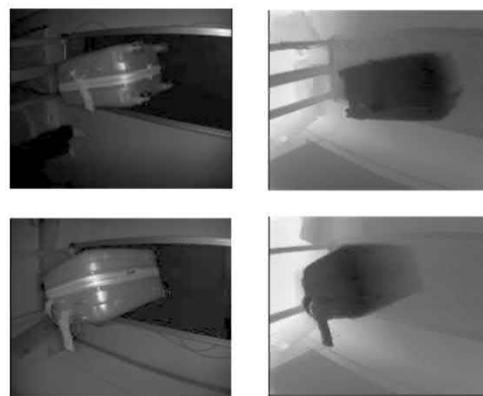
1D DATA



2D DATA

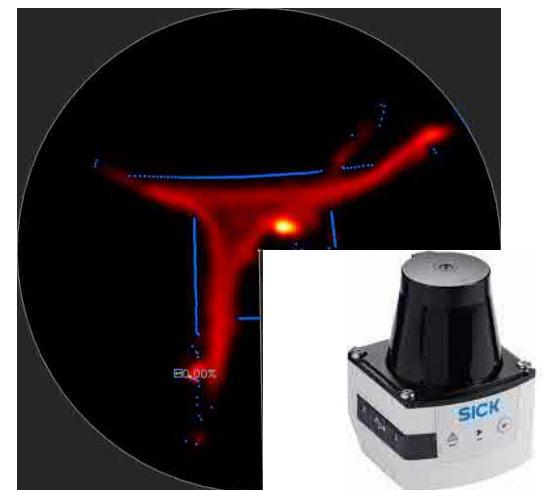
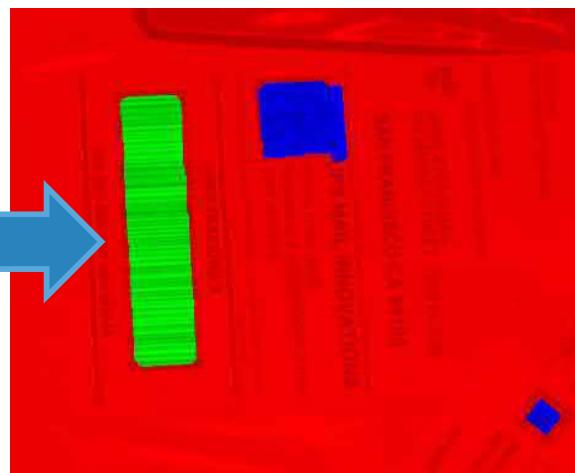
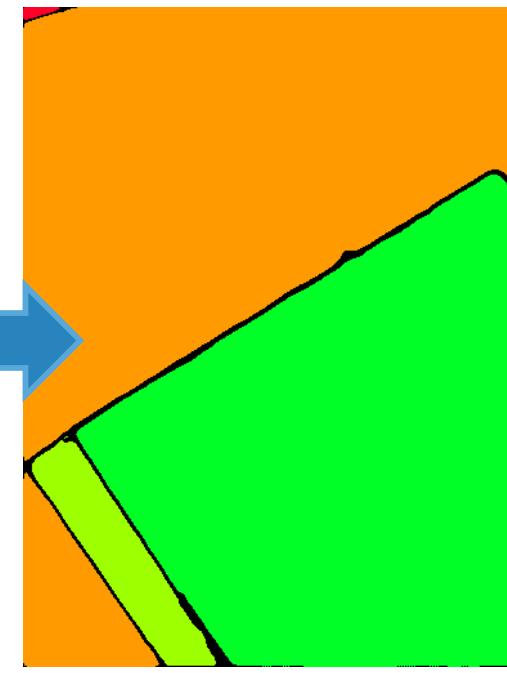
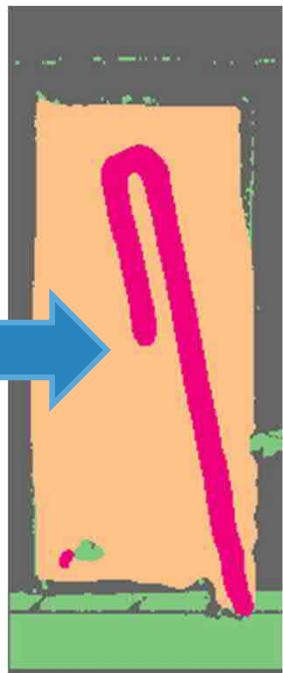


2.5 / 3D DATA



DEEP LEARNING EXAMPLES AT SICK

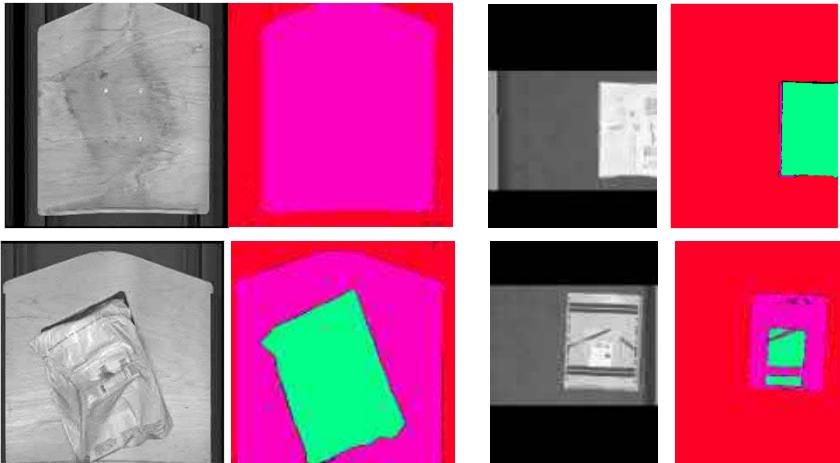
SICK
Sensor Intelligence.



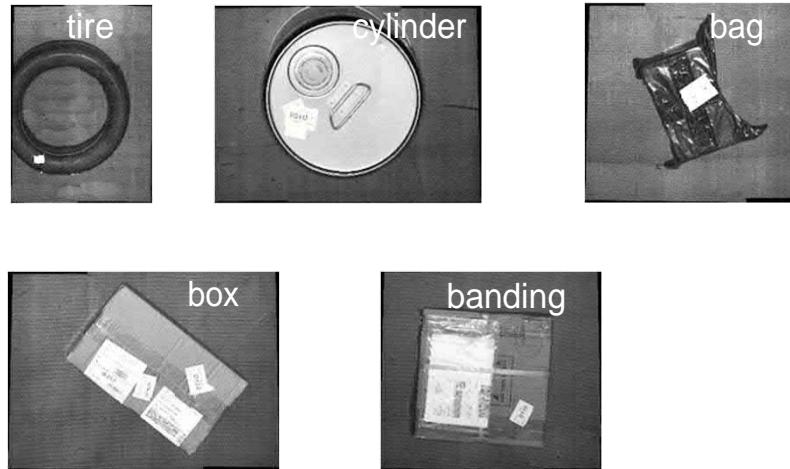
CUSTOMER STORIES



Empty Tray Detection



Object Classification

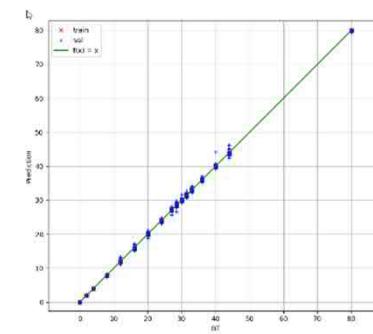


Packaging Classification



SICK

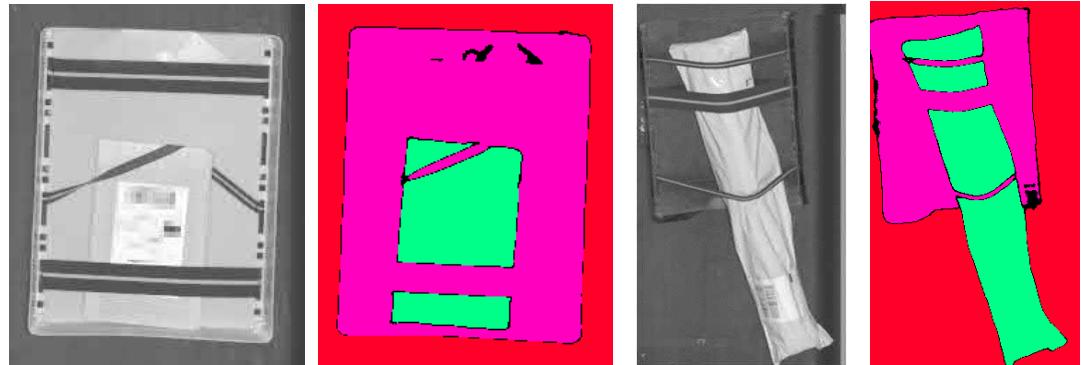
Distance Calculation



Chicken Quality Classification



Tote Detection



Straps Detection



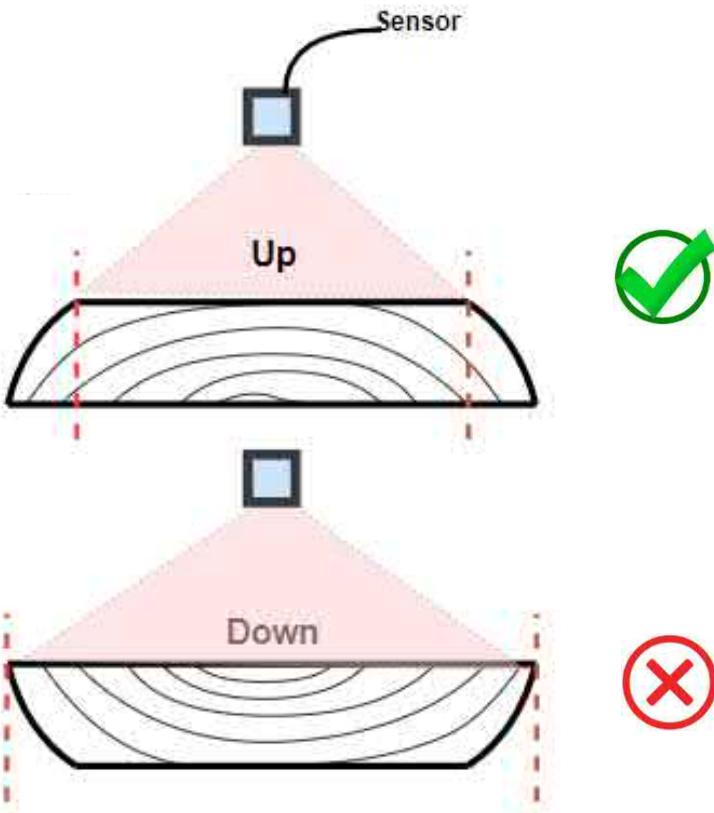
Wood Classification



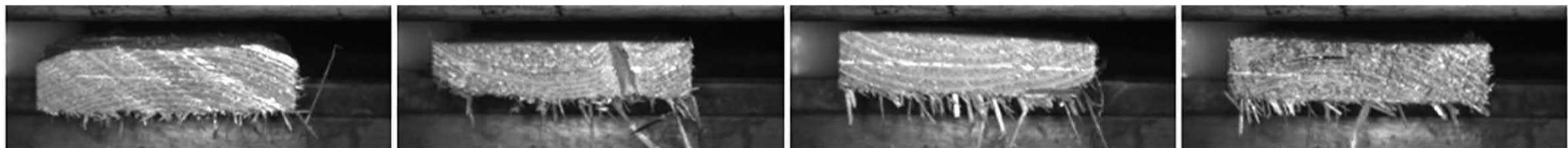
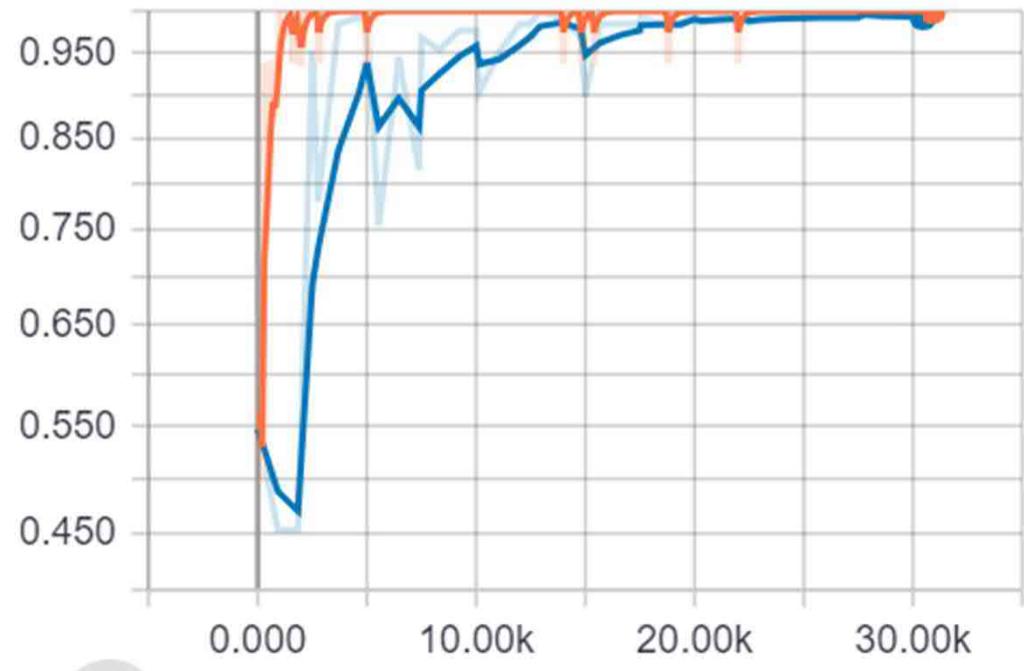
DEEP LEARNING INITIATIVE

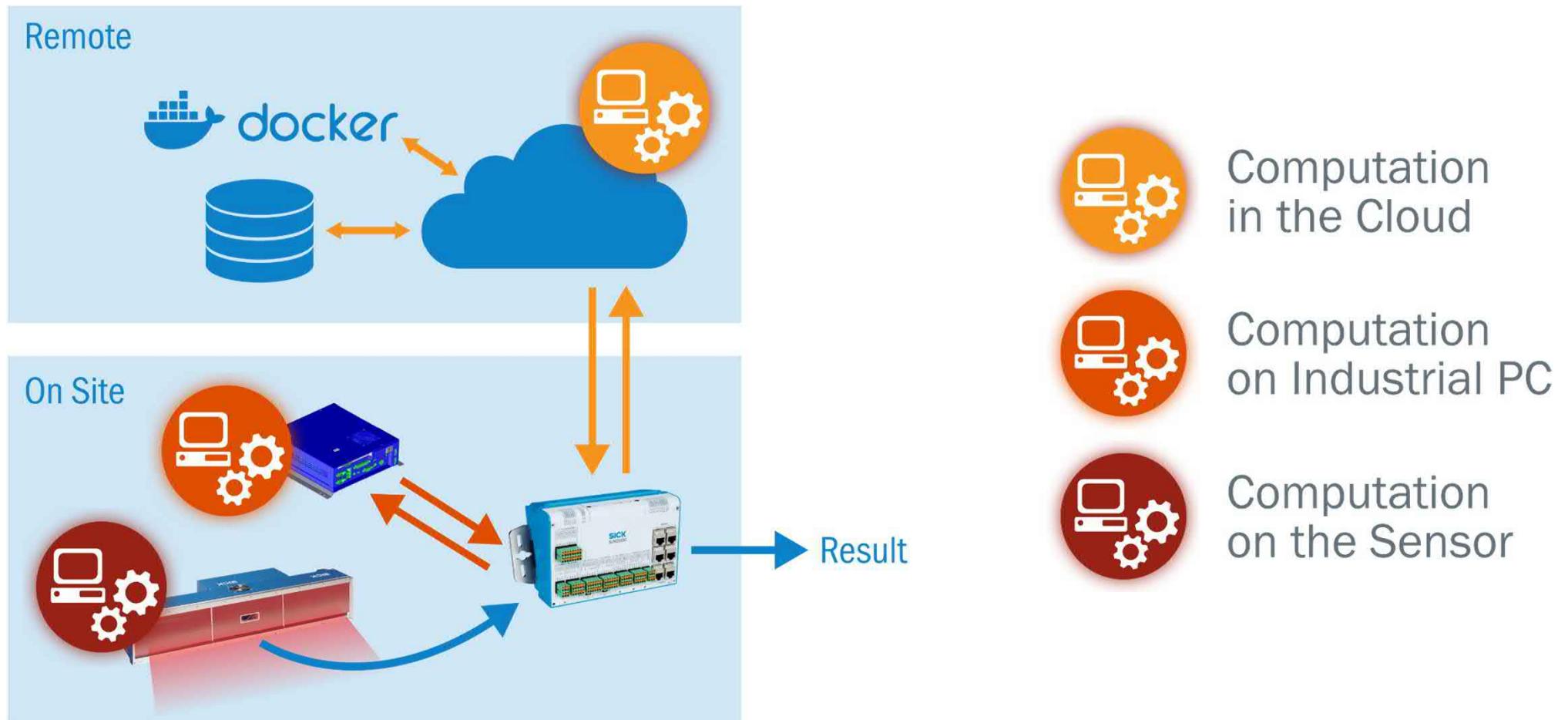
APPLICATION WOOD FLIPPER

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accuracy





[www.SICK.FI](http://www.sick.fi)

[www.SICK.COM](http://www.sick.com)

